



# ESDALC6V1W5

## Quad TRANSIL™ array for data protection

### Main applications

Where transient overvoltage protection in ESD sensitive equipment is required, such as :

- Computers
- Printers
- Communication systems
- Cellular phones and accessories
- Wireline and wireless telephone sets
- Set top boxes

### Features

- 4 Unidirectional Transil functions
- Breakdown voltage:  
 $V_{BR} = 6.1$  V minimum
- Low leakage current:  $< 1$   $\mu$ A
- Low capacitance: 7.5 pF at 3 V
- Very small PCB area  $< 4.2$  mm<sup>2</sup> typically

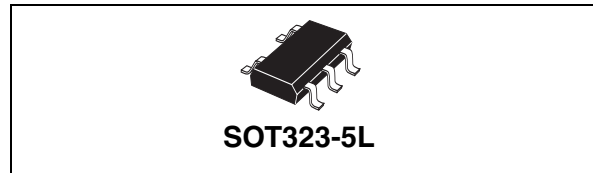
### Description

The ESDALCxxxWx are monolithic suppressors designed to protect components connected to data and transmission lines against ESD.

These devices clamp the voltage just above the logic level supply for positive transients, and to a diode drop below ground for negative transients.

### Benefits

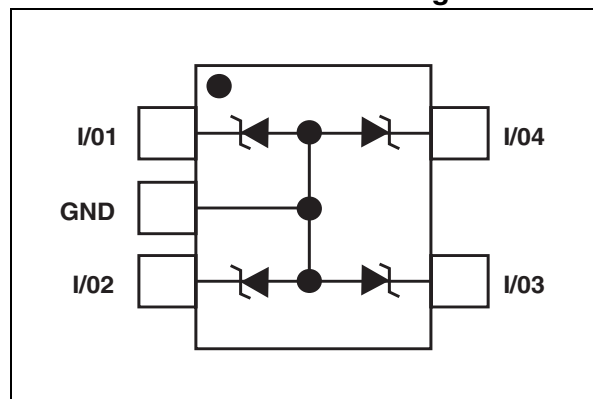
- High ESD protection level: up to 25 kV
- High integration



### Order codes

Part Number	Marking
ESDALC6V1W5	C61

### ESDALC6V1W5 Functional diagram



### Complies with the following standards

#### IEC61000-4-2

Level 4	15 kV (air discharge) 8 kV (contact discharge)
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#### MIL STD 883E - Method 3015-7 Class 3

25 kV HBM (Human Body Model)

TM: TRANSIL is a trademark of STMicroelectronics

# 1 Characteristics

**Table 1. Absolute Ratings ( $T_{amb} = 25^{\circ}C$ )**

Symbol	Parameter	Value	Unit
$P_{PP}$	Peak pulse power (8/20 $\mu$ s)	25	W
$T_j$	Junction temperature	150	$^{\circ}C$
$T_{stg}$	Storage temperature range	-55 to +150	$^{\circ}C$
$T_L$	Maximum lead temperature for soldering during 10s	260	$^{\circ}C$
$T_{op}$	Operating temperature range <sup>(1)</sup>	-40 to +150	$^{\circ}C$

1. The values of the operating parameters versus temperature are given through curves and  $\alpha T$  parameter.

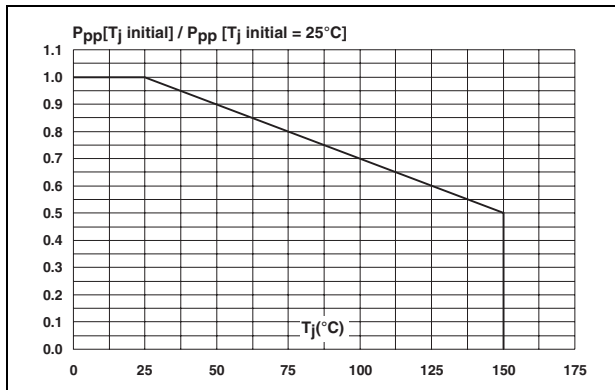
## 1.1 Electrical Characteristics ( $T_{amb} = 25^{\circ}C$ )

Symbol	Parameter
$V_{RM}$	Stand-off voltage
$V_{BR}$	Breakdown voltage
$V_{CL}$	Clamping voltage
$I_{RM}$	Leakage current
$I_{PP}$	Peak pulse current
$I_R$	Reverse leakage current
$I_F$	Forward current
$\alpha T$	Voltage temperature coefficient
$V_F$	Forward voltage drop
C	Capacitance
$R_d$	Dynamic resistance

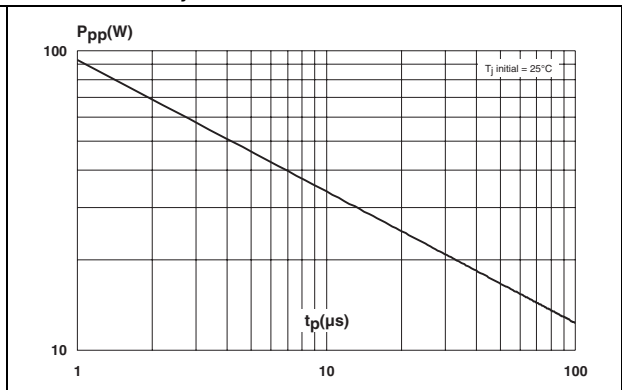
Part Numbers	$V_{BR} @ I_R$		$I_{RM} @ V_{RM}$			$R_d$	$\alpha T$	C
	min.	max.	max.			typ. <sup>(1)</sup>	max. <sup>(2)</sup>	typ. 3V bias
	V	V	mA	$\mu$ A	V	$\Omega$	$10^{-4}/^{\circ}C$	pF
ESDALC6V1W5	6.1	7.2	1	1	3	1.1	6	7.5

1. Square pulse  $I_{pp} = 15$  A,  $t_p = 2.5$   $\mu$ s
2.  $V_{BR} = aT * (T_{amb} - 25^{\circ}C) + V_{BR}(25^{\circ}C)$

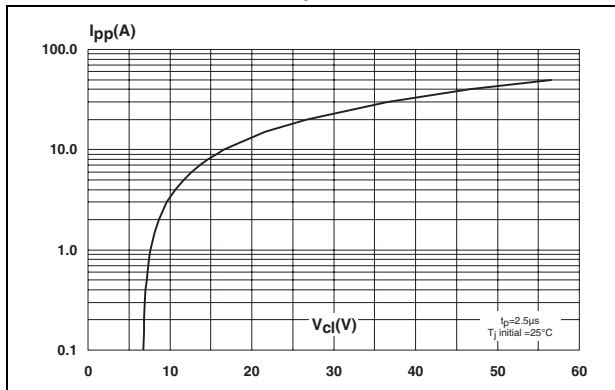
**Figure 1. Peak power dissipation versus initial junction temperature**



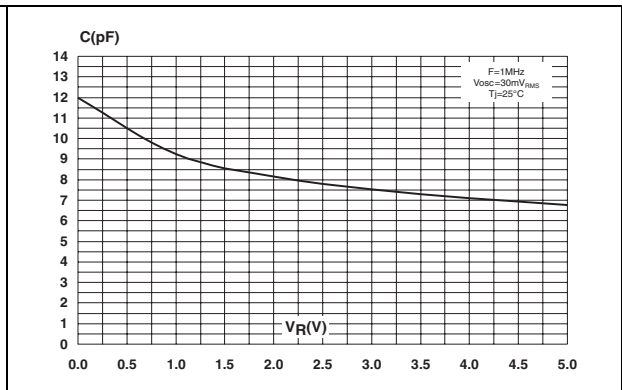
**Figure 2. Peak pulse power versus exponential pulse duration ( $T_j$  initial = 25°C)**



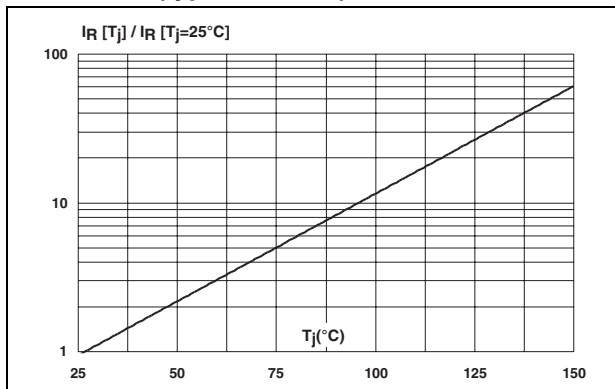
**Figure 3. Clamping voltage versus peak pulse current ( $T_j$  initial = 25°C, rectangular waveform,  $t_p = 2.5 \mu\text{s}$ )**



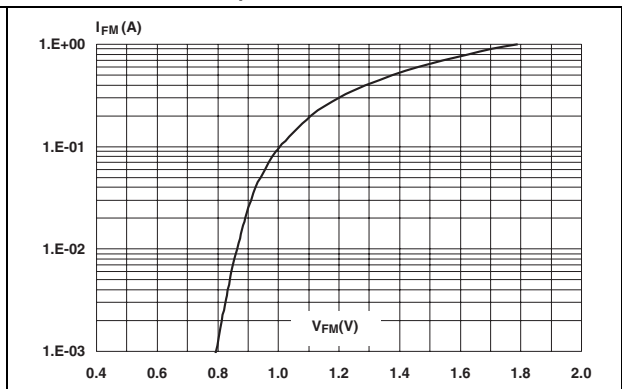
**Figure 4. Capacitance versus reverse applied voltage (typical values)**



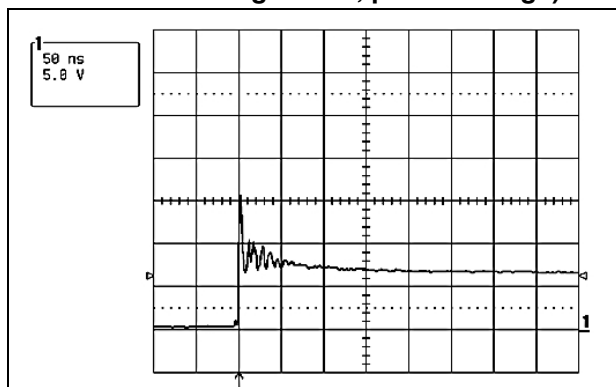
**Figure 5. Relative variation of leakage current versus junction temperature (typical values)**



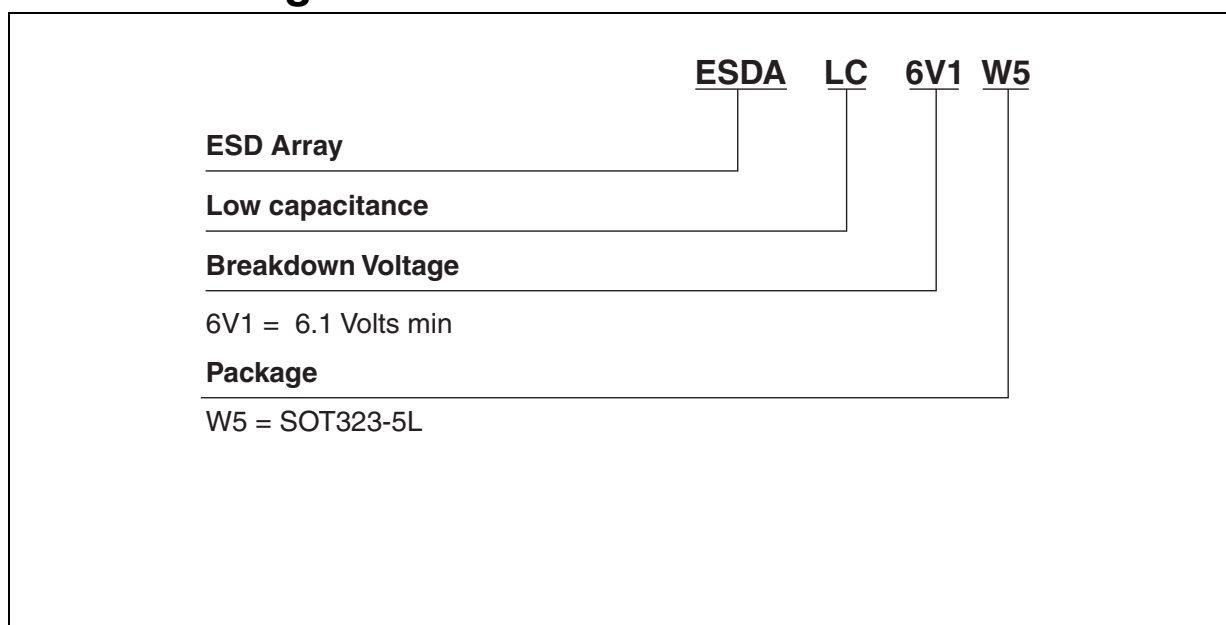
**Figure 6. Peak forward voltage drop versus peak forward current (typical values)**



**Figure 7. ESD response to IEC61000-4-2 (air discharge 15 kV, positive surge)**



## 2 Ordering information scheme



### 3 Package mechanical data

#### 3.1 SOT323-5L package

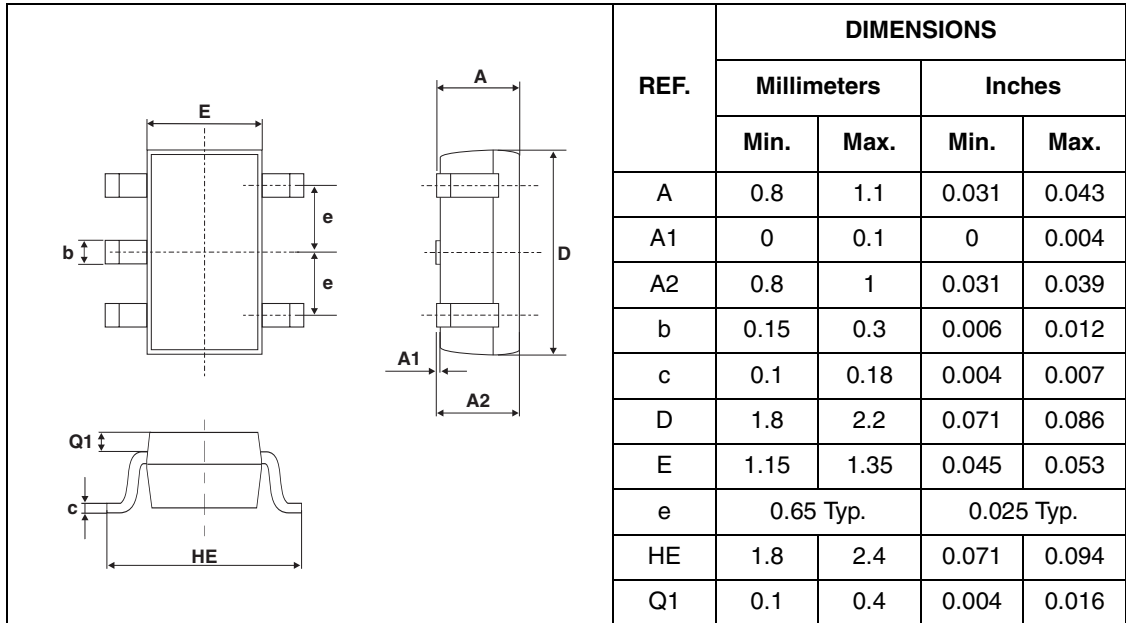
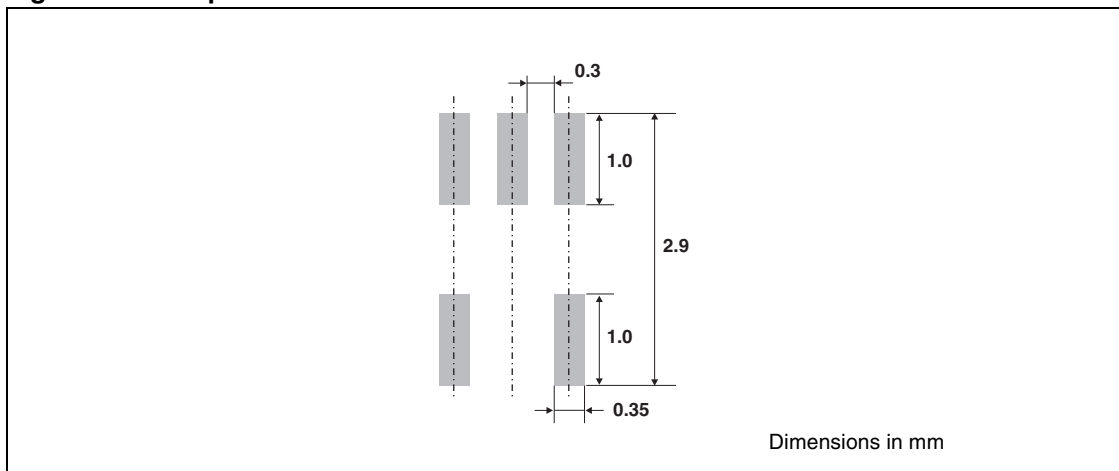


Figure 8. Footprint dimensions



In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect . The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: [www.st.com](http://www.st.com).

## 4 Ordering information

Part Number	Marking	Package	Weight	Base qty	Delivery mode
ESDALC6V1W5	C61	SOT323-5L	5.4 mg	3000	Tape & reel

## 5 Revision history

Date	Revision	Changes
Jun-2002	4A	Previous issue
10-Jan-2006	5	Reformatted to current template. Figure 5: Range of $T_j$ extended to 150 °C. Figure 6: Peak forward voltage drop versus peak forward current (typical values) added.

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